

Thyristor Modules

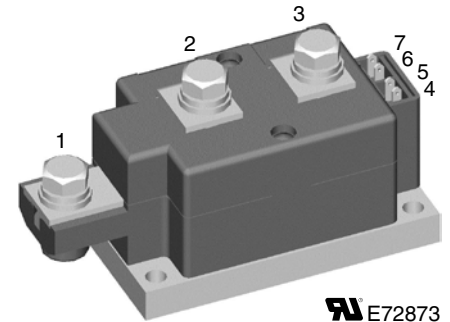
Thyristor/Diode Modules

$$I_{TRMS} = 2 \times 450 \text{ A}$$

$$I_{TAVM} = 2 \times 250 \text{ A}$$

$$V_{RRM} = 1200-1800 \text{ V}$$

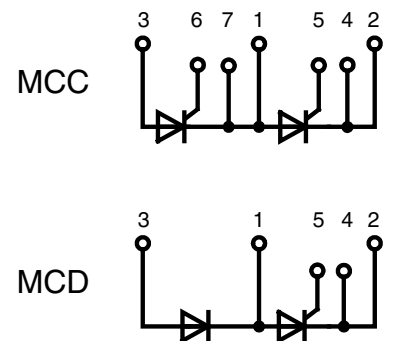
V_{RSM} V_{DSM} V	V_{RRM} V_{DRM} V	Type	
1300	1200	MCC 255-12io1	MCD 255-12io1
1500	1400	MCC 255-14io1	MCD 255-14io1
1700	1600	MCC 255-16io1	MCD 255-16io1
1900	1800	MCC 255-18io1	MCD 255-18io1



 E72873

Symbol	Conditions	Maximum Ratings			
I_{TRMS}, I_{FRMS} I_{TAVM}, I_{FAVM}	$T_{VJ} = T_{VJM}$ $T_C = 85^{\circ}\text{C}; 180^{\circ}$ sine	450 250	A A		
I_{TSM}, I_{FSM}	$T_{VJ} = 45^{\circ}\text{C};$ $V_R = 0$	$t = 10\text{ ms}$ (50 Hz) $t = 8.3\text{ ms}$ (60 Hz)	9000 9600	A A	
	$T_{VJ} = T_{VJM};$ $V_R = 0$	$t = 10\text{ ms}$ (50 Hz) $t = 8.3\text{ ms}$ (60 Hz)	7800 8600	A A	
	I^2t	$T_{VJ} = 45^{\circ}\text{C};$ $V_R = 0$	$t = 10\text{ ms}$ (50 Hz) $t = 8.3\text{ ms}$ (60 Hz)	405 000 382 000	A^2s A^2s
		$T_{VJ} = T_{VJM};$ $V_R = 0$	$t = 10\text{ ms}$ (50 Hz) $t = 8.3\text{ ms}$ (60 Hz)	304 000 307 000	A^2s A^2s
$(di/dt)_{cr}$	$T_{VJ} = T_{VJM};$ $f = 50\text{ Hz}; t_p = 200\text{ }\mu\text{s};$	repetitive, $I_T = 860\text{ A}$	100	$\text{A}/\mu\text{s}$	
	$V_D = \frac{2}{3} V_{DRM};$ $I_G = 1\text{ A};$ $di_G/dt = 1\text{ A}/\mu\text{s}$	non repetitive, $I_T = I_{TAVM}$	500	$\text{A}/\mu\text{s}$	
$(dv/dt)_{cr}$	$T_{VJ} = T_{VJM}; V_D = \frac{2}{3} V_{DRM};$ $R_{GK} = \infty;$ method 1 (linear voltage rise)		1000	$\text{V}/\mu\text{s}$	
P_{GM}	$T_{VJ} = T_{VJM};$ $t_p = 30\text{ }\mu\text{s}$ $I_T = I_{T(AV)M};$ $t_p = 500\text{ }\mu\text{s}$		120 60 20	W W W	
P_{GAV}					
V_{RGM}			10	V	
T_{VJ}			-40...+130	$^{\circ}\text{C}$	
T_{VJM}			130	$^{\circ}\text{C}$	
T_{stg}			-40...+125	$^{\circ}\text{C}$	
V_{ISOL}	50/60 Hz, RMS $t = 1\text{ min}$		3000	V~	
	$I_{ISOL} \leq 1\text{ mA}$ $t = 1\text{ s}$		3600	V~	
M_d	Mounting torque (M6)		4.5 - 7	Nm	
	Terminal connection torque (M8)		11 - 13	Nm	
Weight	Typical including screws		750	g	

Data according to IEC 60747 and refer to a single diode unless otherwise stated.



Features

- International standard package
- Direct Copper Bonded Al_2O_3 -ceramic with copper base plate
- Planar passivated chips
- Isolation voltage 3600 V~
- UL registered, E 72873
- Keyed gate/cathode twin pins

Applications

- Motor control, softstarter
- Power converter
- Heat and temperature control for industrial furnaces and chemical processes
- Lighting control
- Solid state switches

Advantages

- Simple mounting
- Improved temperature and power cycling
- Reduced protection circuits

Symbol	Conditions	Characteristic Values	
		typ.	max.
I_{RRM}, I_{DRM}	$V_R / V_D = V_{RRM} / V_{DRM}$ $T_{VJ} = T_{VJM}$		40 mA
V_T, V_F	$I_T, I_F = 600$ A $T_{VJ} = 25^\circ\text{C}$		1.36 V
V_{T0}	For power-loss calculations only		0.8 V
r_t	$T_{VJ} = T_{VJM}$		0.68 mΩ
V_{GT}	$V_D = 6$ V $T_{VJ} = 25^\circ\text{C}$ $T_{VJ} = -40^\circ\text{C}$		2 V 3 V
I_{GT}	$V_D = 6$ V $T_{VJ} = 25^\circ\text{C}$ $T_{VJ} = -40^\circ\text{C}$		150 mA 220 mA
V_{GD}	$V_D = \frac{2}{3} V_{DRM}$ $T_{VJ} = T_{VJM}$		0.25 V
I_{GD}			10 mA
I_L	$t_p = 30$ μs; $V_D = 6$ V $I_G = 0.45$ A; $di_G/dt = 0.45$ A/μs $T_{VJ} = 25^\circ\text{C}$		200 mA
I_H	$V_D = 6$ V; $R_{GK} = \infty$; $T_{VJ} = 25^\circ\text{C}$		150 mA
t_{gd}	$V_D = \frac{1}{2} V_{DRM}$ $I_G = 1$ A; $di_G/dt = 1$ A/μs $T_{VJ} = 25^\circ\text{C}$		2 μs
t_q	$V_D = \frac{2}{3} V_{DRM}$ $dv/dt = 50$ V/μs; $-di/dt = 10$ A/μs $I_T = 300$ A; $V_R = 100$ V; $t_p = 200$ μs $T_{VJ} = T_{VJM}$	200	μs
Q_S	$I_T = 300$ A; $-di/dt = 50$ A/μs $T_{VJ} = T_{VJM}$		760 μC
I_{RM}			275 A
R_{thJC}	per thyristor; DC current per module		0.139 K/W 0.07 K/W
R_{thJK}	per thyristor; DC current per module		0.179 K/W 0.09 K/W
d_s	Creeping distance on surface		12.7 mm
d_A	Creepage distance in air		9.6 mm
a	Maximum allowable acceleration		50 m/s ²

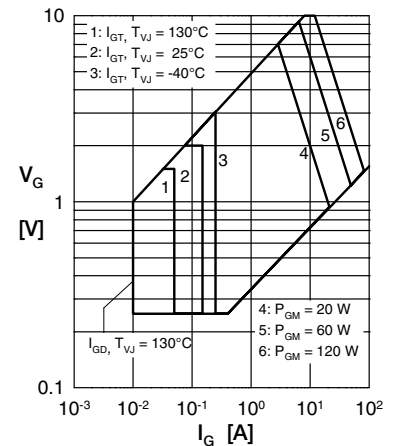


Fig. 3 Surge overload current
 $I_{TSM/FSM}$: Crest value, t : duration

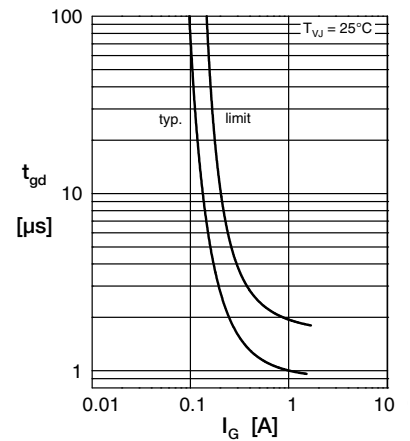
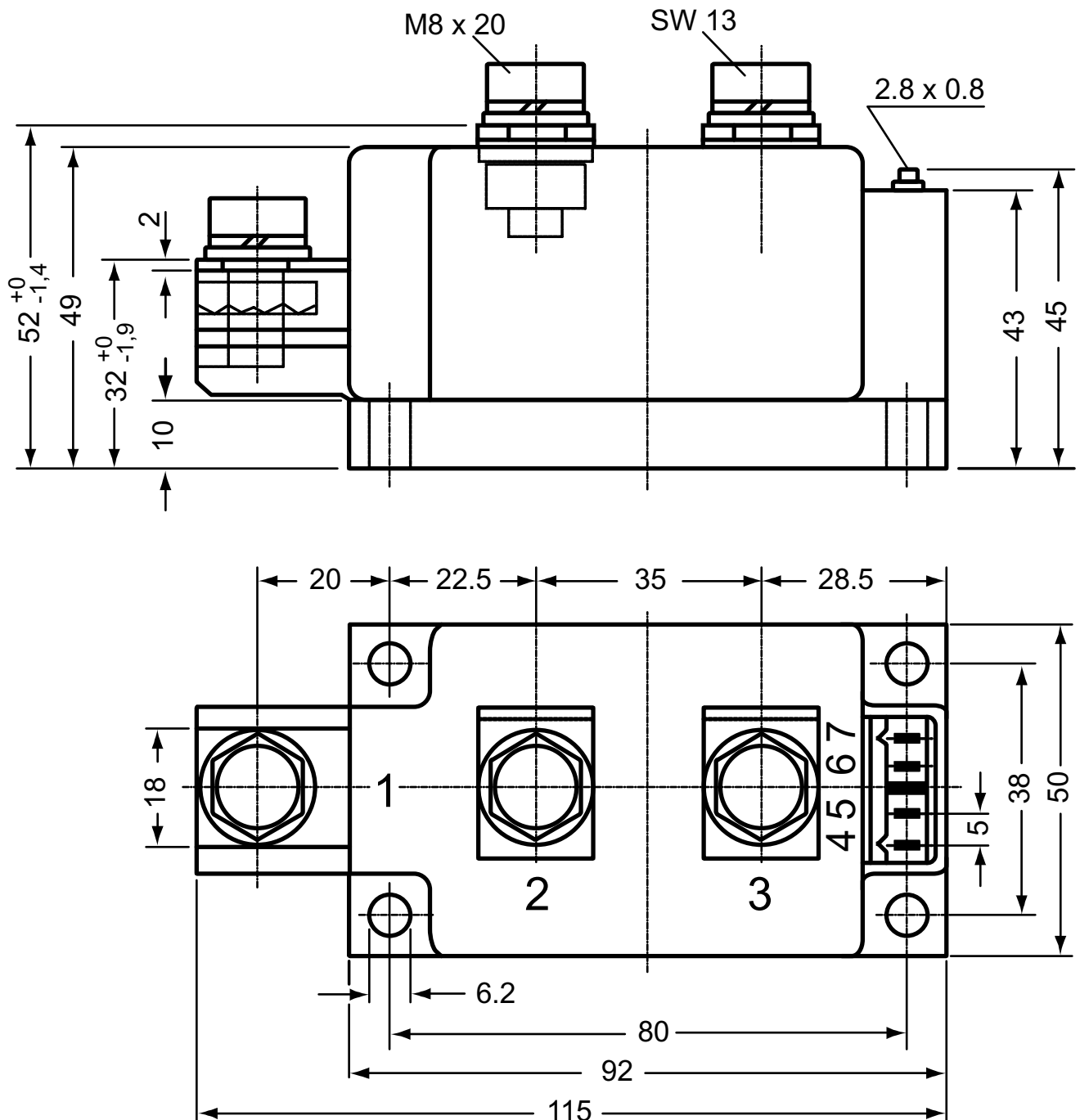


Fig. 2 Gate trigger delay time

Dimensions in mm (1 mm = 0.0394")



Optional accessories for modules

Keyed gate/cathode twin plugs with wire length = 350 mm, gate = white, cathode = red

Type ZY 180L (L = Left for pin pair 4/5)

Type ZY 180R (R = Right for pin pair 6/7) } UL 758, style 3751

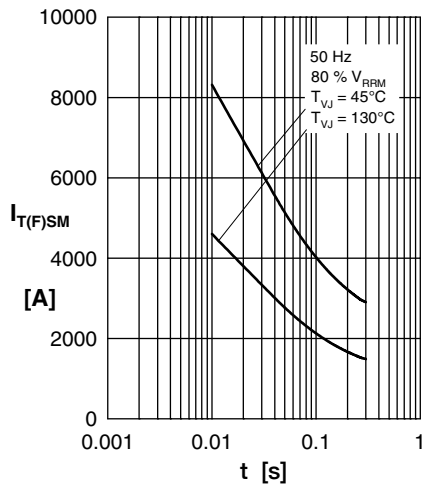


Fig. 3 Surge overload current
 $I_{T(F)SM}$: Crest value, t: duration

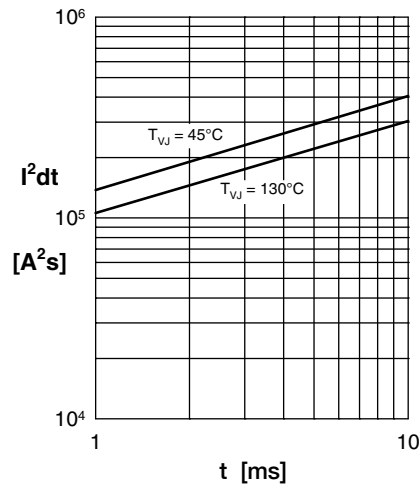


Fig. 4 I^2dt versus time

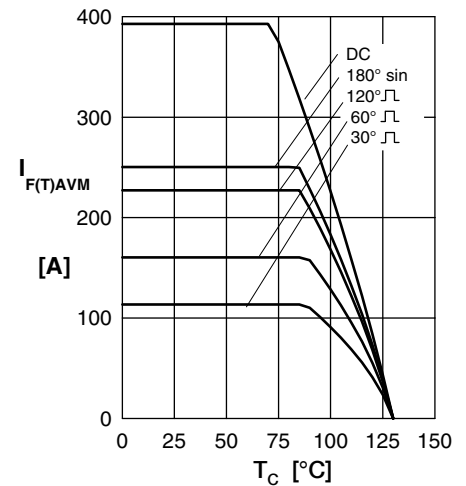


Fig. 4a Max. forward current
at case temperature

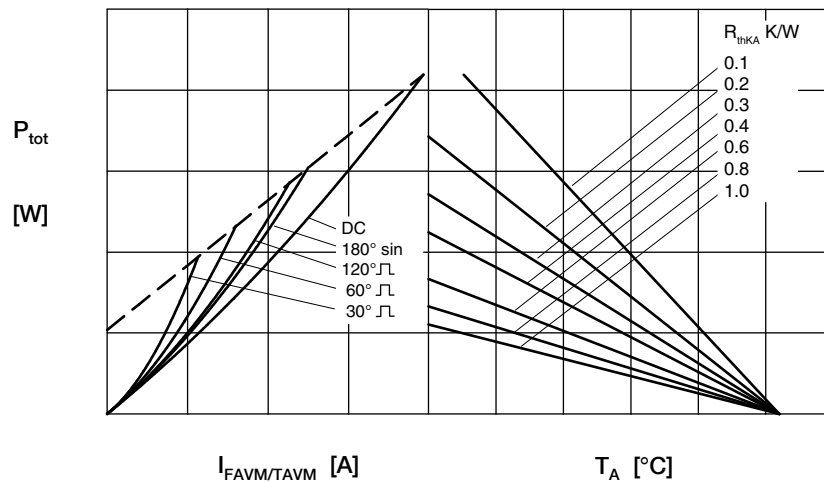


Fig. 5 Power dissipation versus on-state current and
ambient temperature (per thyristor or diode)

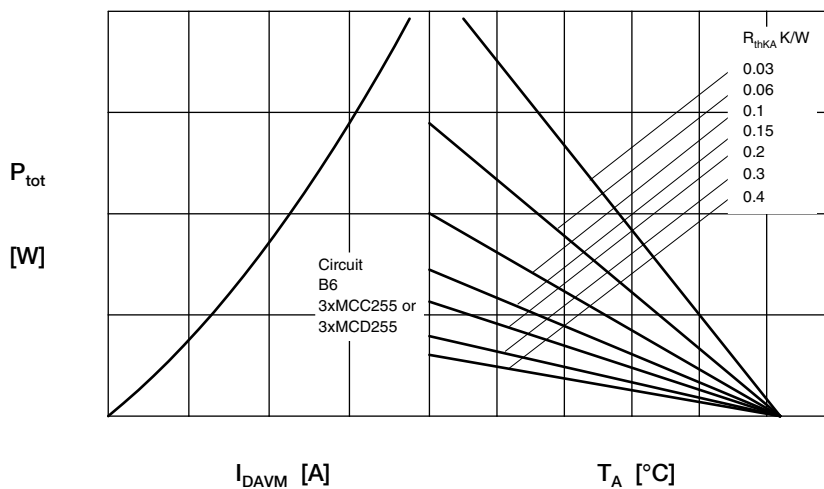


Fig. 6 Three phase rectifier bridge: Power dissipation versus direct
output current and ambient temperature

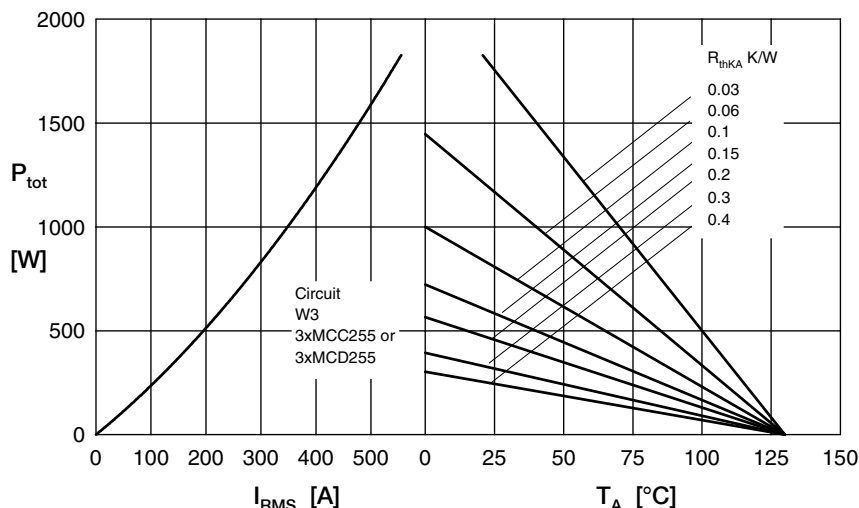


Fig. 7 Three phase AC-controller: Power dissipation versus R_{MS} output current and ambient temperature

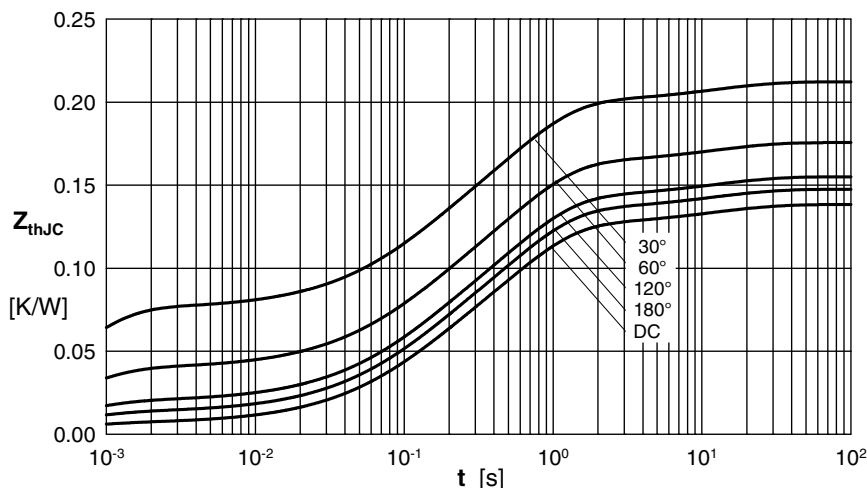


Fig. 8 Transient thermal impedance junction to case (per thyristor/diode)

R_{thJC} for various conduct. angles d:

d	R_{thJC} (K/W)
DC	0.139
180°	0.148
120°	0.156
60°	0.176
30°	0.214

Constants for Z_{thJC} calculation:

i	R_{thi} (K/W)	t_i (s)
1	0.0066	0.00054
2	0.0358	0.098
3	0.0831	0.54
4	0.0129	12

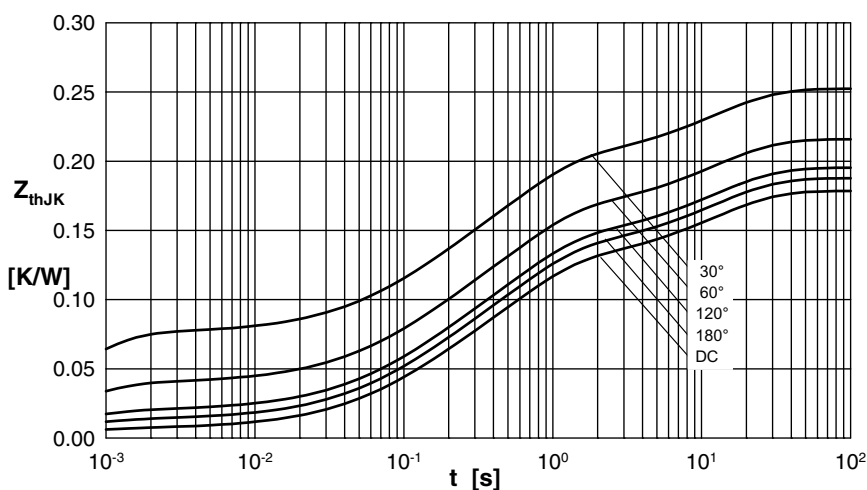


Fig. 9 Transient thermal impedance junction to heatsink (per thyristor/diode)

R_{thJK} for various conduct. angles d:

d	R_{thJK} (K/W)
DC	0.179
180°	0.188
120°	0.196
60°	0.216
30°	0.254

Constants for Z_{thJK} calculation:

i	R_{thi} (K/W)	t_i (s)
1	0.0066	0.00054
2	0.0358	0.098
3	0.0831	0.54
4	0.0129	12
5	0.04	12

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